

Product Specification

NHD-C12864LZ-FSW-FBW-3V3

COG (Chip-on Glass) Liquid Crystal Display Module

NHD- Newhaven Display

C12864- 128 x 64 Pixels

LZ- Model

F- Transflective

SW- Side white LED Backlight

F- FSTN (+)

B- 6:00 Optimal View

W- Wide Temperature

3V3- 3.0V LCD, 3.0V Backlight







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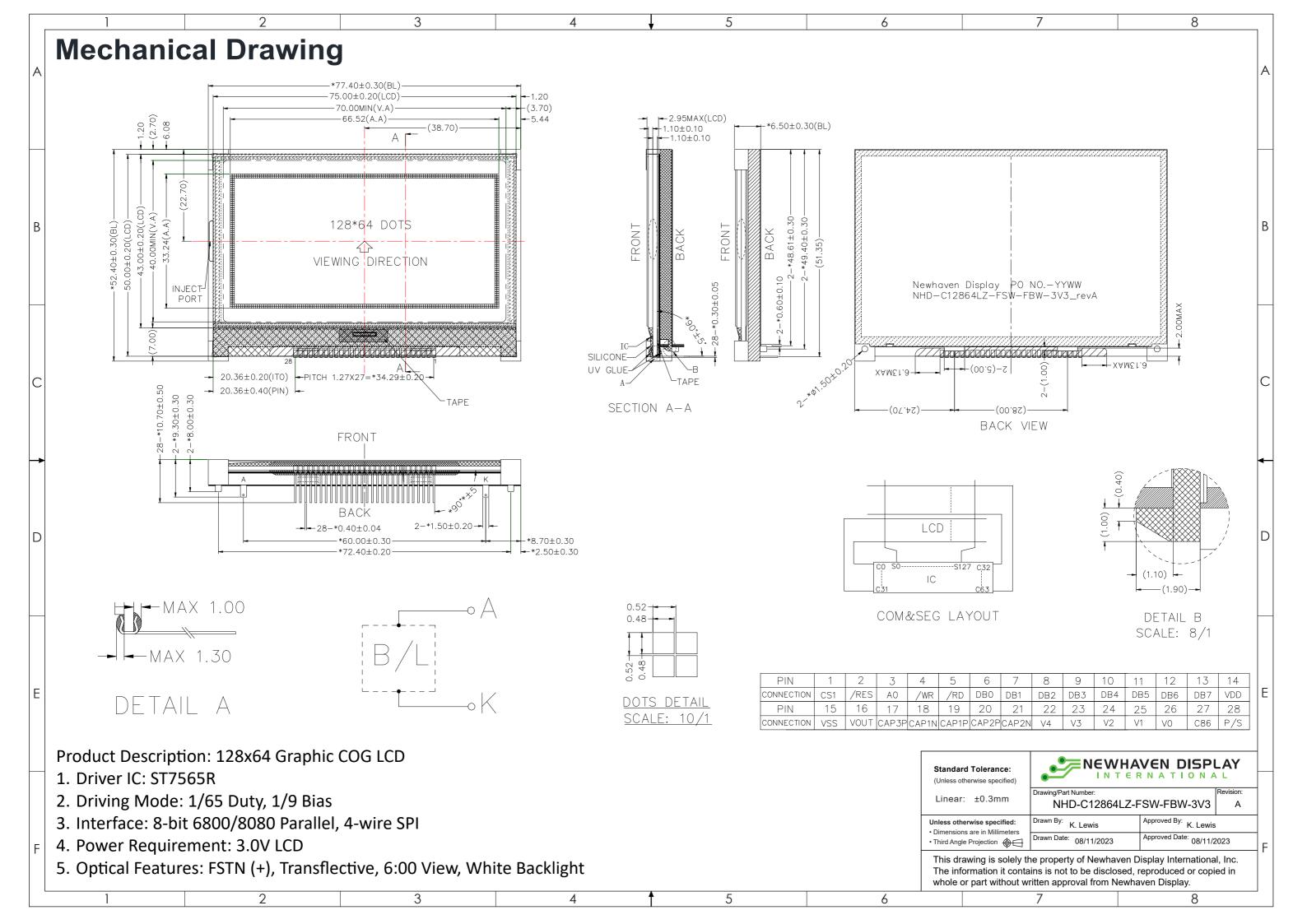
Additional Resources

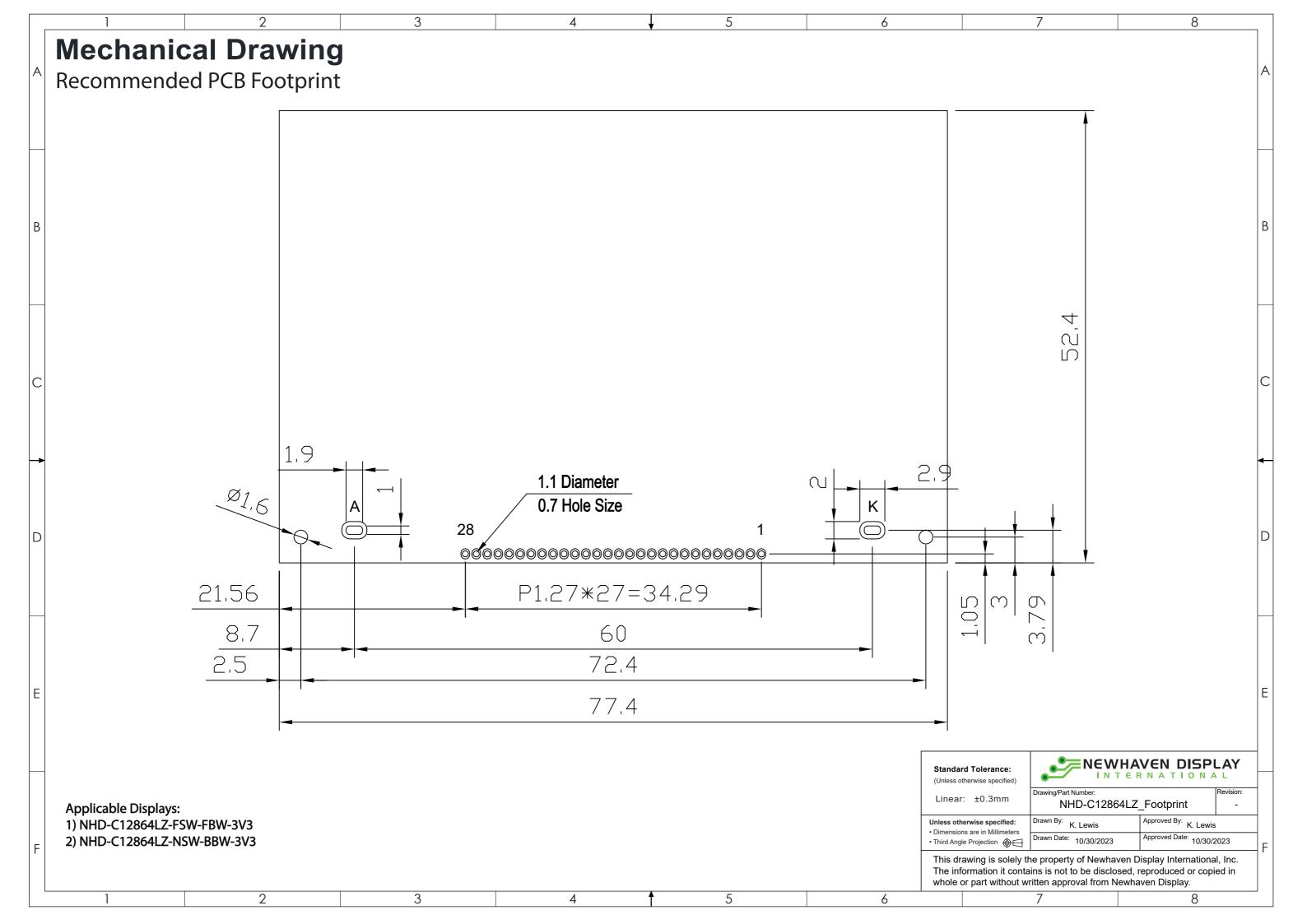
- Support Forum: https://support.newhavendisplay.com/hc/en-us/community/topics
- ➤ **GitHub:** https://github.com/newhavendisplay
- **Example Code:** https://support.newhavendisplay.com/hc/en-us/categories/4409527834135-Example-Code/
- ➤ Knowledge Center: https://www.newhavendisplay.com/knowledge center.html
- ➤ Quality Center: https://www.newhavendisplay.com/quality_center.html
- Precautions for using LCDs/LCMs: https://www.newhavendisplay.com/specs/precautions.pdf
- ➤ Warranty / Terms & Conditions: https://www.newhavendisplay.com/terms.html



Document Revision History

Revision	Date	Description	Changed By
0	01/10/2010	Initial Release	MC
1	07/07/2011	Packaging Procedure Added	AK
2	12/12/2012	Example Initialization Program Updated	AK
3	04/10/2013	Serial Interface Timing Added	AK
4	03/17/2015	Pin Description Updated	RM
5	10/16/2015	Mechanical Drawing Updated	TJ
6	06/29/2016	Electrical and Optical Characteristics Updated	SB
7	10/27/2016	Electrical Characteristics and Mechanical Drawing Updated	TM
8	07/26/2017	Backlight Redesign & LCD Panel Changed for Improved Contrast	SB
9	08/24/2018	Note Added to Drawing	SB
10	05/28/2019	Added PCB Footprint Drawing & Recommended Breakout Board	AS
11	08/11/2023 Updated Optical Characteristics, Quality Information, Timing Characteristics, and Date Code Format on Mechanical Drawing		KL
12	10/30/2023	PCB Footprint Added	KL







Pin Description

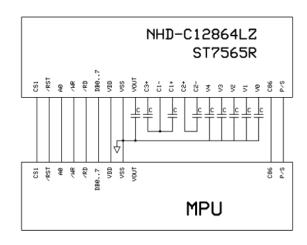
Pin No.	Symbol	External Connection	Function Description
1	/CS1	MPU	Active LOW chip select
2	/RES	MPU	Active LOW Reset signal
3	A0	MPU	Register select signal. 0: instruction; 1: data register
4	R/W	MPU	6800 Mode: Read/Write select signal. R/W=1: Read R/W: =0:
	/WR		Write
			8080 Mode: Active LOW Write Signal
5	E	MPU	6800 Mode: Active HIGH Enable Signal
	/RD		8080 Mode: Active LOW Read Signal
6	DB0	MPU	Parallel Interface:
7	DB1	MPU	DB0-DB7: Bi-directional 8-bit data bus
8	DB2	MPU	Serial Interface:
9	DB3	MPU	DB0-DB5: No connect in serial mode
10	DB4	MPU	DB6= Serial clock (SCL)
11	DB5	MPU	DB7= Serial data input (SI)
12	DB6	MPU	
13	DB7	MPU	
14	V_{DD}	Power Supply	Supply Voltage for LCD and logic (+3.0V)
15	V_{SS}	Power Supply	Ground
16	V _{OUT}	Power Supply	Connect to 1uF cap to VSS
17	CAP3+	Power Supply	Connect to 1uF cap to CAP1- (PIN-18)
18	CAP1-	Power Supply	Connect to 1uF cap to CAP3+(PIN17) and CAP1+(PIN19)
19	CAP1+	Power Supply	Connect to 1uF cap to CAP1- (PIN-18)
20	CAP2+	Power Supply	Connect to 1uF cap to CAP2- (PIN-21)
21	CAP2-	Power Supply	Connect to 1uF cap to CAP2+ (PIN-20)
22	V_4	Power Supply	1.0uF-2.2uF cap to VSS
23	V_3	Power Supply	1.0uF-2.2uF cap to VSS
24	V ₂	Power Supply	1.0uF-2.2uF cap to VSS
25	V ₁	Power Supply	1.0uF-2.2uF cap to VSS
26	V ₀	Power Supply	1.0uF-2.2uF cap to VSS
27	C86	MPU	MPU interface Select pin. C86=H: 6800; C86=L: 8080
28	PS	MPU	Parallel/Serial select. PS= H: Parallel; PS=L: Serial

LCD connector: 1.27mm pitch pins.

Backlight connector: 1.5mm wide pins.

Recommended Breakout Board: NHD-PCB40

Wiring Diagram





Electrical Characteristics

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Operating Temperature Range	Тор	Absolute Max	-20	-	+70	°C
Storage Temperature Range	T _{ST}	Absolute Max	-30	-	+80	°C
Supply Voltage	V _{DD}	-	2.7	3.0	3.3	V
Supply Current	I _{DD}	V _{DD} = 3.0V	0.2	0.5	2.0	mA
Supply for LCD (contrast)	V_{LCD}	$T_{OP} = 25^{\circ}C$	8.2	8.5	8.8	V
"H" Level input	V _{IH}	-	0.8 * V _{DD}	•	V_{DD}	V
"L" Level input	VIL	-	Vss	•	0.2 * V _{DD}	V
"H" Level output	V _{OH}	-	0.8 * V _{DD}	ı	V_{DD}	V
"L" Level output	Vol	-	Vss	-	0.2 * Vss	V
LED Backlight current	I _{LED}	-	60	80	100	mA
LED Backlight voltage	V _{LED}	I _{LED} = 80mA	2.7	3.0	3.3	V

^{*}The LED of the backlight is driven by current drain; drive voltage is for reference only. Drive voltage must be selected to ensure backlight current drain is below MAX level stated.

Optical Characteristics

	Ite	em	Symbol	Condition	Min.	Тур.	Max.	Unit		
Omtimod	Тор		, Тор		φΥ+		-	40	-	0
Optimal	Bot	tom	φΥ-	C= > 2	-	40	-	0		
Viewing Angles	Left		θХ-	Cr ≥ 2	-	35	-	0		
Angles	Righ	nt	θХ+		-	35	-	0		
Contrast Rat	Contrast Ratio		CR	-	-	5	-	-		
Response Time		Rise	Tr	T 25°C	-	150	-	ms		
		Fall	Tf	$T_{OP} = 25^{\circ}C$	-	110	-	ms		

Controller Information

Built-in ST7565R Controller: https://support.newhavendisplay.com/hc/en-us/articles/4414899357591-ST7565R



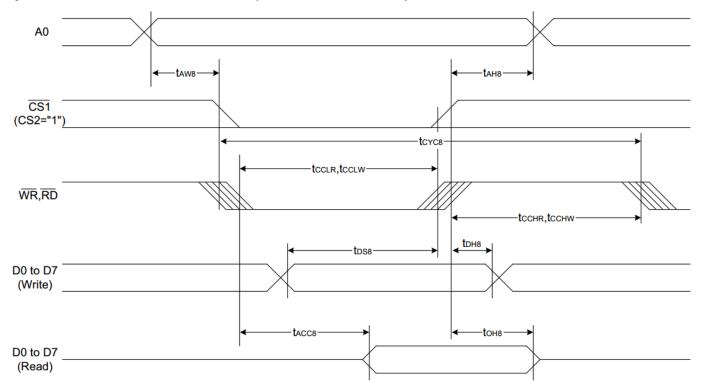
Table of Commands

Command					Com	mano	d Coc	le				Function
Command	A0	/RD	/WR	D7	D6	D5	D4	D3	D2	D1	D0	Function
(1) Display ON/OFF	0	1	0	1	0	1	0	1	1	1	0 1	LCD display ON/OFF 0: OFF, 1: ON
(2) Display start line set	0	1	0	0	1		Disp	lay st	art a	ddres	ss	Sets the display RAM display start line address
(3) Page address set	0	1	0	1	0	1	1	Р	age	addre	ess	Sets the display RAM page address
(4) Column address set upper bit Column address set lower bit	0	1	0	0	0	0	1	co Le	lumn ast s	ignific addı ignific addı	ress cant	Sets the most significant 4 bits of the display RAM column address. Sets the least significant 4 bits of the display RAM column address.
(5) Status read	0	0	1		Sta	itus		0	0	0	0	Reads the status data
(6) Display data write	1	1	0					W	rite d	ata		Writes to the display RAM
(7) Display data read	1	0	1					Re	ead d	ata		Reads from the display RAM
(8) ADC select	0	1	0	1	0	1	0	0	0	0	0	Sets the display RAM address SEG output correspondence 0: normal, 1: reverse
(9) Display normal/ reverse	0	1	0	1	0	1	0	0	1	1	0 1	Sets the LCD display normal/ reverse 0: normal, 1: reverse
(10) Display all points ON/OFF	0	1	0	1	0	1	0	0	1	0	0 1	Display all points 0: normal display 1: all points ON
(11) LCD bias set	0	1	0	1	0	1	0	0	0	1	0 1	Sets the LCD drive voltage bias ratio 0: 1/9 bias, 1: 1/7 bias (ST7565R)
(12) Read-modify-write	0	1	0	1	1	1	0	0	0	0	0	Column address increment At write: +1 At read: 0
(13) End	0	1	0	1	1	1	0	1	1	1	0	Clear read/modify/write
(14) Reset	0	1	0	1	1	1	0	0	0	1	0	Internal reset
(15) Common output mode select	0	1	0	1	1	0	0	0	*	*	*	Select COM output scan direction 0: normal direction 1: reverse direction
(16) Power control set	0	1	0	0	0	1	0	1	0	perat mod		Select internal power supply operating mode
(17) V ₀ voltage regulator internal resistor ratio set	0	1	0	0	0	1	0	0	Res	sistor	ratio	Select internal resistor ratio(Rb/Ra) mode
(18) Electronic volume mode set Electronic volume	0	1	0	1	0	0	0	0	0	0	1	Set the V ₀ output voltage electronic volume register
register set				0	0	E	lectro	onic v	/olum	ne va	lue	Ciccuonic volume register
(19) Sleep mode set	0	1	0	1	0	1	0	1	1	0	0 1	0: Sleep mode, 1: Normal mode
(.5) 5.55p 11.5do 50t		•	•	*	*	*	*	*	*	0	0	
(20) Booster ratio set	0	1	0	1	1	1	1	1	0	0	0	select booster ratio 00: 2x,3x,4x
(_3)				0	0	0	0	0	0		p-up ilue	01: 5x 11: 6x
(21) NOP	0	1	0	1	1	1	0	0	0	1	1	Command for non-operation
(22) Test	0	1	0	1	1	1	1	*	*	*	*	Command for IC test. Do not use this command



Timing Characteristics

System Bus Read/Write Characteristics 1 (For the 8080 Series MPU)

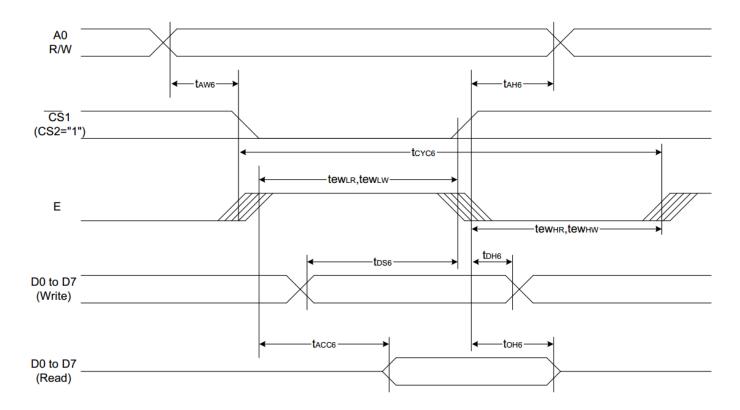


(VDD = 3.3V, Ta = -30 to 85%)

ltem	Cianal	Symbol	Condition	Rat	ing	Units
item	Signal	Symbol	Condition	Min.	Max.	Units
Address hold time		tah8		0	_	
Address setup time	A0	taw8		0	_	
System cycle time		tcyc8		240	_	
Enable L pulse width (WRITE)	WR	tcclw		80	_	
Enable H pulse width (WRITE)	VVIX	tccнw		80	_	
Enable L pulse width (READ)	RD	tcclr		140	_	Ns
Enable H pulse width (READ)	KD.	tcchr		80		
WRITE Data setup time		tDS8		40	_	
WRITE Address hold time	D0 to D7	t _{DH8}		0	_	
READ access time	D0 10 D7	tacc8	CL = 100 pF	_	70	
READ Output disable time		toн8	CL = 100 pF	5	50	



System Bus Read/Write Characteristics 2 (For the 6800 Series MPU)

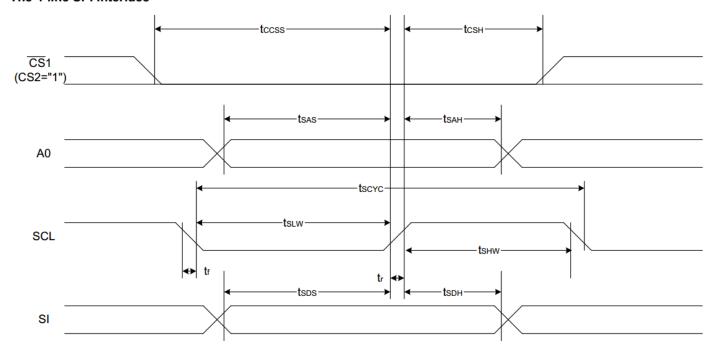


(VDD = 3.3V, Ta = -30 to 85%)

				(1000)
Item	Signal	Symbol	Condition	Rat	ing	Units
item	Signal	Symbol	Condition	Min.	Max.	Units
Address hold time		tah6		0	_	
Address setup time	A0	taw6		0	_	
System cycle time]	tcyc6		240	_	
Enable L pulse width (WRITE)	WR	tewlw		80	_	
Enable H pulse width (WRITE)	VVK	tewnw		80	_	
Enable L pulse width (READ)	DD	tewlr		80	_	ns
Enable H pulse width (READ)	RD	tewhr		140		
WRITE Data setup time		tDS6		40	_	
WRITE Address hold time	D0 to D7	tDH6		0	_	
READ access time	D0 to D7	tacc6	CL = 100 pF	_	70	
READ Output disable time]	toн6	CL = 100 pF	5	50	1



The 4-line SPI Interface



(VDD = 3.3V, Ta = -30 to 85%)

	a		0 !!!!	Rati	ing	11
Item	Signal	Symbol	Condition	Min.	Max.	Units
4-line SPI Clock Period		Tscyc		50	_	
SCL "H" pulse width	SCL	Tshw		25	_]
SCL "L" pulse width		Tslw		25	_]
Address setup time	4.0	Tsas		20	_]
Address hold time	A0	Tsah		10	_	ns
Data setup time	SI	Tsds		20	_]
Data hold time	31	Тѕон		10	_]
CS-SCL time	CC	Tcss		20	_]
CS-SCL time	CS	Tcsh		40	_	



Reset Timing

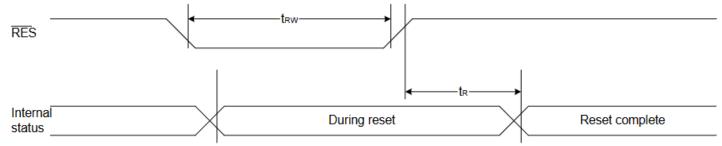


Figure 41

Table 30

 $(VDD = 3.3V, Ta = -30 \text{ to } 85^{\circ}C)$

Item	Signal	Symbol	Condition		Units			
Item	Signal	Syllibol	Condition	Min.	Тур.	Max.	Units	
Reset time		tr		_	_	1.0	us	
Reset "L" pulse width	/RES	trw		1.0	_	_	us	

Table 31

(VDD = 2.7V, Ta = -30 to 85%)

Item	Signal	Cumbal	Condition		Units			
item	Signal	Symbol	Condition	Min.	Тур.	Max.	UIIILS	
Reset time		tr		_	_	2.0	us	
Reset "L" pulse width	/RES	trw		2.0	_	_	us	



Example Initialization Program

```
void comm_out(unsigned int c)
        CS1 = 0;
                                  //Active Low
         AO = 0;
                                  //LOW = instruction
        delay(1);
        WRT = 0;
                                  // /WR in 8080 mode; R/W in 6800 mode
        P1 = c;
         delay(1);
                                  // /WR in 8080 mode; R/W in 6800 mode
        WRT = 1;
        CS1 = 1;
                                  //inactive
        delay(5);
}
void data out(unsigned int d)
{
        CS1 = 0;
                                 //Active Low
         AO = 1;
                                  //High = Data
        delay(1);
        WRT = 0;
         //RDD = 1;
        P1 = d;
        delay(1);
        WRT = 1;
                                  //inactive
        CS1 = 1;
}
void init()
{
        RDD = 1;
                                  // /RD in 8080 mode; E in 6800 mode
                                  // /WR in 8080 mode; R/W in 6800 mode
        WRT = 1;
        CS1 = 0;
        RST = 1:
                                  // /RST in 8080 mode; /RES in 6800 mode
                                  ///RST in 8080 mode; /RES in 6800 mode
        RST = 0;
        delay(2);
                                  // /RST in 8080 mode; /RES in 6800 mode
        RST = 1;
        delay(2);
                                 //added 1/9 bias
        comm_out(0xA2);
                                  //ADC segment driver direction (A0=Normal)
        comm_out(0xA0);
        comm_out(0xC8);
                                  //added
                                  //COM output scan direction (CO= Normal)
        comm out(0xC0);
        comm_out(0x40);
                                  //Operating Mode
        delay(0);
        comm_out(0x25);
                                  //resistor ratio
        delay(0);
        comm_out(0x81);
                                 //electronic volume mode set
        delay(0);
        comm out(0x19);
                                  //electronic volume register set
        delay(0);
        comm_out(0x2F);
                                  //power control set
        delay(0);
                                 //display ON/OFF - set to ON
        comm_out(0xAF);
```



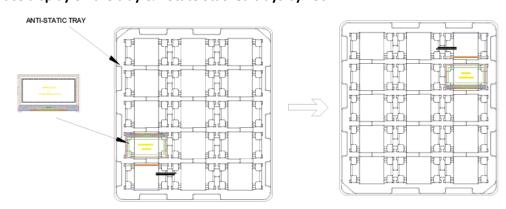
Packing Procedure

1. Packing Materials

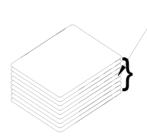
NO.	Item	Dimensions (LxWxH) (mm)	Quantity
1	Tray	366x296x21.1	15
2	Вох	382x310x165	105
3	Carton	400x321x363	210

2. Packing Method

A. Place display on the tray & Rotate Stacked trays by 180°



В.

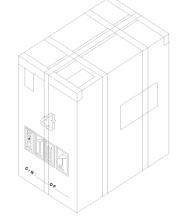


7 FULL TRAYS 1 EMPTY TRAY











Quality Information

Test Item	Content of Test	Test Condition	Note
High Temperature storage	Endurance test applying the high storage temperature for a long time.	+80°C , 96hrs	2
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-30°C , 96hrs	1,2
High Temperature Operation	Endurance test applying the electric stress (voltage & current) and the high thermal stress for a long time.	+70°C , 96hrs	2
Low Temperature Operation	Endurance test applying the electric stress (voltage & current) and the low thermal stress for a long time.	-20°C , 96hrs	1,2
High Temperature / Humidity Operation	Endurance test applying the electric stress (voltage & current) and the high thermal with high humidity stress for a long time.	+40°C, 90% RH, 96hrs	1,2
Thermal Shock resistance	Endurance test applying the electric stress (voltage & current) during a cycle of low and high thermal stress.	-30°C, 30min -> 25°C, 5min -> 80°C, 30min = 1 cycle For 10 cycles	
Vibration test	Endurance test applying vibration to simulate transportation and use.	Frequency: 250 times/minute Swing Distance: 1 inch Direction: Stochastic For 45 min	3
Static electricity test	Endurance test applying electric static discharge.	AIR:± 8KV;Touch Glass± 4KV 5 times	

Note 1: No condensation to be observed.

Note 2: Conducted after 4 hours of storage at 25°C, 0%RH.

Note 3: Test performed on product itself, not inside a container.